

RS2A/A - RS2M/A

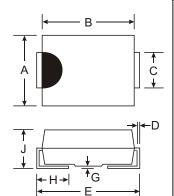
1.5A SURFACE MOUNT FAST RECOVERY RECTIFIER

Features

- Glass Passivated Die Construction
- Fast Recovery Time For High Efficiency
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- Plastic Material: UL Flammability Classification Rating 94V-0

Mechanical Data

- Case: Molded Plastic
- Terminals: Solder Plated Terminal -Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.065 grams (approx.)
- SMB Weight: 0.09 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



	SI	ЛА	SMB						
Dim	Min	Мах	Min	Max					
Α	2.29	2.92	3.30	3.94					
В	4.00	4.60	4.06	4.57					
С	1.27	1.63	1.96	2.21					
D	0.15	0.31	0.15	0.31					
Е	4.80	5.59	5.00	5.59					
G	0.10	0.20	0.10	0.20					
н	0.76	1.52	0.76	1.52					
J	2.01	2.62	2.00	2.62					
All Dimensions in mm									



Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	RS2 A/AA	RS2 B/BA	RS2 D/DA	RS2 G/GA	RS2 J/JA	RS2 K/KA	RS2 M/MA	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage		V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_T = 120^{\circ}C$		lo	1.5							Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load (JEDEC Method)		I _{FSM}	50							A
Forward Voltage @ I _F = 1.5A		VFM	1.3							V
Peak Reverse Current@ $T_A = 25^{\circ}C$ at Rated DC Blocking Voltage@ $T_A = 125^{\circ}C$		I _{RM}	5.0 200							μA
Reverse Recovery Time (Note 3)		t _{rr}	150			250	250 500		ns	
Typical Junction Capacitance (Note 2)		Cj	30							pF
Typical Thermal Resistance, Junction to Terminal (Note 1)		R _{0JT}	20							K/W
Operating and Storage Temperature Range		T _j , T _{STG}	-65 to +150						°C	

Notes: 1. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Reverse Recovery Test Conditions: I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A. See Figure 5.



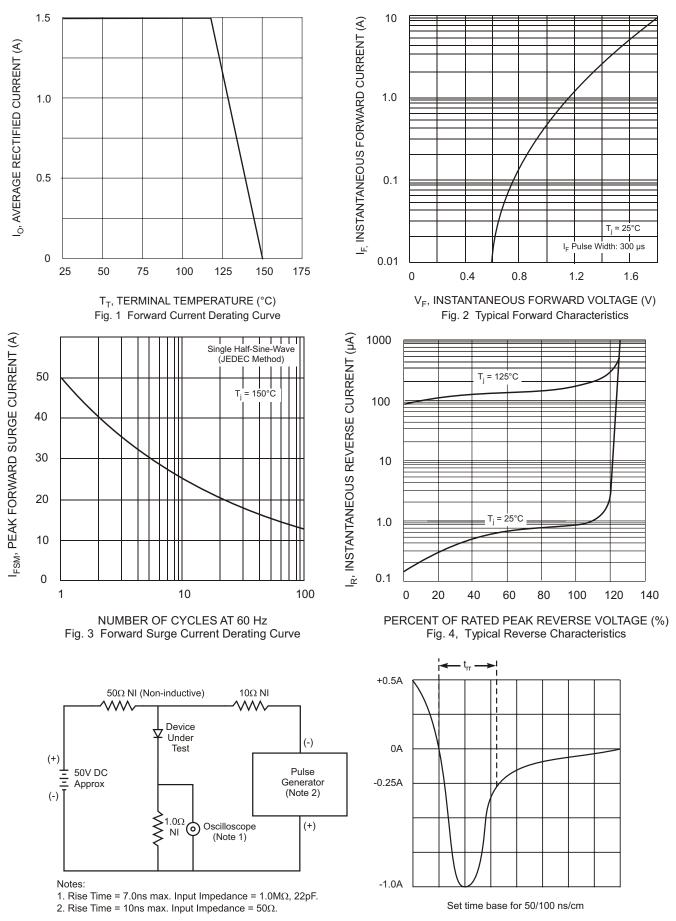


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

单击下面可查看定价,库存,交付和生命周期等信息

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